OKI Semiconductor

This version: Jul. 2000
Previous version: May 1998

MSM9842

Playback LSI with Built-in FIFO

This document contains minimum specifications. For full specifications, please contact your nearest Oki office or representative.

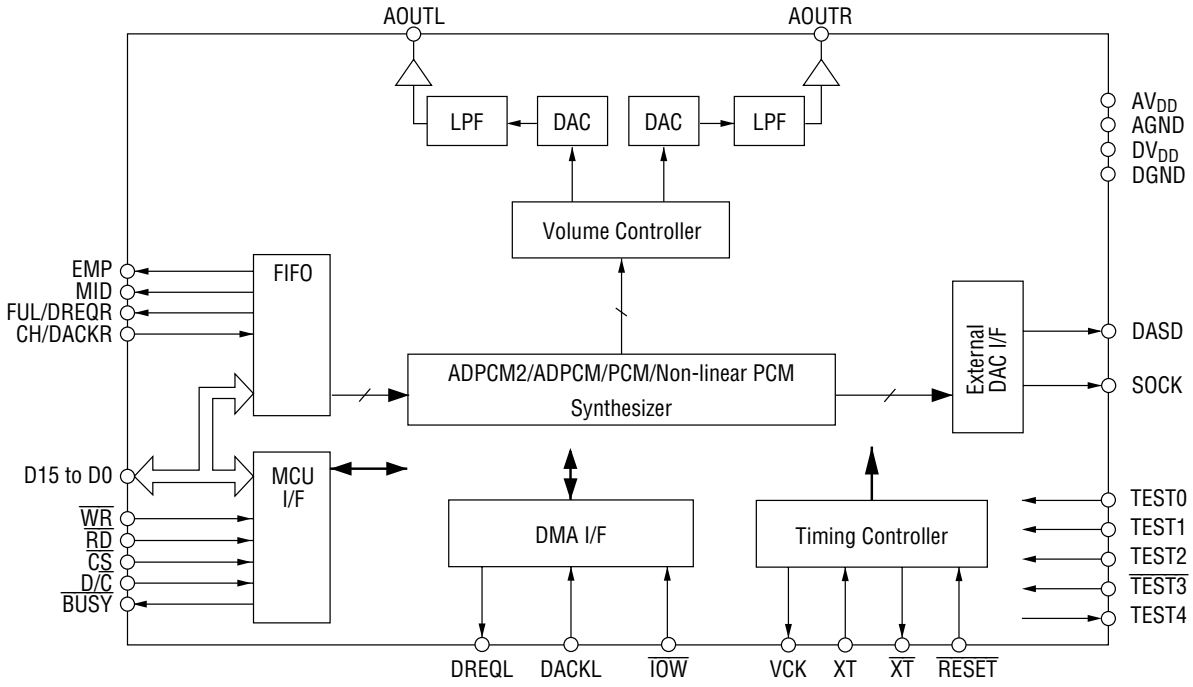
GENERAL DESCRIPTION

The MSM9842 is a mono/stereo playback LSI with a built-in 1K bit FIFO for easy interface with external systems or non-semiconductor memory. It utilizes multiple playback modes, including the new ADPCM2 algorithm, which allows for even higher quality sound reproduction. The playback function of the MSM9842 is controlled by an MCU via 8/16-bit bus interface.

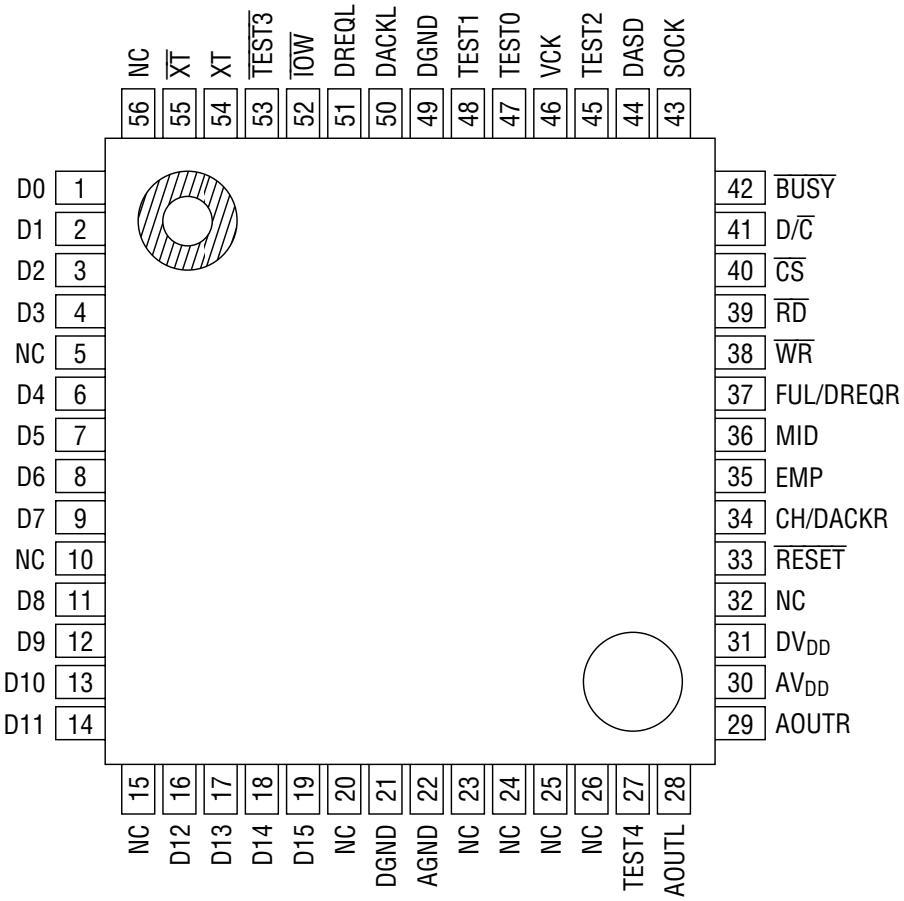
FEATURES

- 16/8-bit bus interface support
- FIFO capacity: User-definable (256/512/1024 bits)
  (buffering time of 32 ms when using 8 kHz sampling frequency, 4-bit ADPCM2/ADPCM, and in monaural playback)
- Supports four compression algorithms for playback:
  4, 5, 6, 7, 8-bit ADPCM2; 4-bit ADPCM; 8; 16-bit PCM; and 8-bit Nonlinear PCM
- Sampling frequency: 4.0 kHz, 6.4 kHz, 8.0 kHz, 12.8 kHz, 16.0 kHz, 32.0 kHz (fosc=4.096 MHz)
- Sampling frequency: 22.05 kHz, 44.1 kHz (fosc=5.6448 MHz)
- DMA interface support
- Volume control (8 steps: 0 dB to –21 dB)
- Built-in 14-bit D/A converter
- Built-in low pass filter (LPF)
- Power supply voltage: 2.7 V to 5.5 V
- Package:
  56-pin plastic QFP (QFP56-P-910-0.65-2K) (Product name: MSM9842GA)

BLOCK DIAGRAM



PIN CONFIGURATION (TOP VIEW)



NC : No Connection

56-pin plastic QFP

PIN DESCRIPTIONS

Symbol	Type	Description
D15-D8	I/O	For 8-bit bus interface, the command allows these pins to be configured to be inputs to input data to and from an external memory. Otherwise, these pins are configured to be inputs only. For 16-bit interface, these pins are a bidirectional data bus to input data to and from an external microcontroller and memory.
D7-D0	I/O	Birirectional data bus to input data and output status to and from an external microcontroller and memory.
$\overline{WR}$	I	Write pulse input pin. This pin pulses "L" when command or voice data is input to D15-D0 pins.
$\overline{RD}$	I	Read pulse input pin. This pin pulses "L" when status is output to D7-D0 pins.
$\overline{CS}$	I	Accepts write pulse and read pulse when this pin is "L". Does not accept write pulse and read pulse when this pin is "H".
D/$\overline{C}$	I	Voice data is input to D15-D0 pins when this pin is "H". Command is input to and status is output from D7-D0 pins when this pin is "L".
$\overline{BUSY}$	O	This pin outputs a "L" level during, PLAYBACK or PAUSE.
EMP	O	"H" level indicates that there is no data in FIFO memory. Active "H" can be changed to active "L" by command input.
MID	O	"H" level indicates that more than half of the FIFO memory space is filled with data. Voice synthesis starts when MID changes to "H" level. Active "H" can be changed to active "L" by command input. This pin outputs a synchro signal for voice data input when non-use of FIFO is selected.
FUL/DREQR	O	"H" level indicates that FIFO memory is full of data. This pin is "H" and data cannot be written in FIFO memory. Active "H" can be changed to active "L" by command input. When DMA transfer is selected, "H" level DREQR outputs a signal to request a DMA transfer. Active "H" can be changed to active "L" by command input.
CH/DACKR	I	When stereo playback is selected and CH is "H", voice data is written in right FIFO memory, and the EMP, MID or FUL pin outputs the status of right FIFO memory. When CH is "L", data is written in right FIFO memory, and the EMP, MID or FUL pin outputs the status of left FIFO memory. Set this pin to "L" during monophonic playback. When DMA transfer and stereo playback are selected, DACKR is selected. In this case, DACKR outputs a DMA transfer acknowledge signal. When DACKR is "L", the $\overline{IOW}$ signal is accepted. Active "L" can be changed to active "H" by command input.
DREQL	O	When DMA transfer is selected, "H" level DREQL outputs a signal to request a DMA transfer. Active "H" can be changed to active "L" by command input.
DACKL	I	DACKL inputs a signal when DMA transfer is permitted by the DMA controller. When DACKL is "L", $\overline{IOW}$ signal is accepted. When stereo playback is selected, DACKL is a DMA transfer acknowledge signal for left FIFO memory. Active "L" can be changed to active "H" by command input. If DMA transfer is not used, set this pin to "H" level.

PIN DESCRIPTIONS

Symbol	Type	Description
$\overline{IOW}$	I	Signal to write external memory data to MSM9842 during DMA transfer. If DMA transfer is not used, set this pin to "H" level.
DASD	O	16-bit serial data output pin when external DAC is used.
SOCK	O	Synchronizing clock for 16-bit serial data input when external DAC is used.
XT $\overline{XT}$	I O	Oscillator connection pins. When external clock is used, input clock into XT pin and leave $\overline{XT}$ pin open.
VCK	O	Outputs sampling frequency selected at playback. This sampling frequency is used as a synchronizing signal when external DAC is used.
$\overline{RESET}$	I	When this pin is "L", the LSI is initialized.
TEST0 TEST1 TEST2	I	Pins for testing. Set the pins to "L".
$\overline{TEST3}$	I	Pin for testing. Set the pin to "H".
TEST4	O	Pin for testing. Set the pin to "OPEN".
AOUTL	O	Left side output pin for built-in LPF. This is the output pin of playback wavefroms, and is connected to the amplifier for driving speakers.
AOUTR	O	Right side output pin for built-in LPF. This is the output pin of playback wavefroms, and is connected to the amplifier for driving speakers.
DV_{DD}	—	Digital power supply pin. Insert a minimum 0.1 μF bypass capacitor between this pin and DGND pin.
DGND	—	Digital GND pin.
AV_{DD}	—	Analog power supply pin. Insert a minimum 0.1 μF bypass capacitor between this pin and AGND pin.
AGND	—	Analog GND pin.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Rating	Unit
Power Supply Voltage	V_{DD}	Ta=25°C	–0.3 to + 7.0	V
Input Voltage	V_{IN}	Ta=25°C	–0.3 to V_{DD}+ 0.3	V
Storage Temperature	T_{STG}	—	–55 to + 155	°C

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Condition	Range	Unit
Power Supply Voltage	V_{DD}	DGND=AGND=0V	2.7 to 5.5	V
Operating Temperature	T_{OP}	—	–40 to +85	°C
Master Clock Frequency	f_{OSC}	—	4.0 to 6.0	MHz

ELECTRICAL CHARACTERISTICS

DC Characteristics

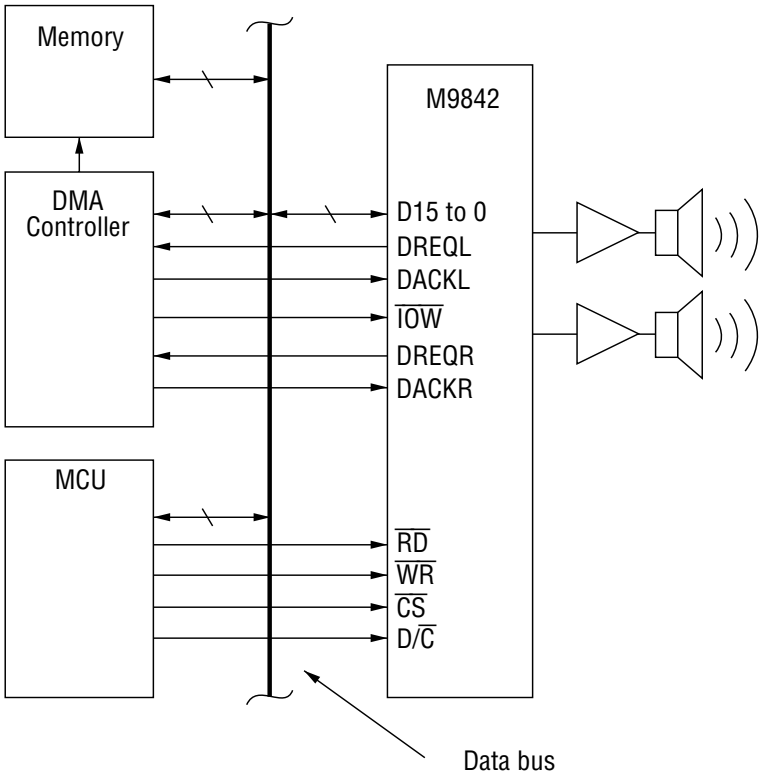
DV_{DD}=AV_{DD}=2.7 to 5.5V, DGND=AGND=0V, Ta=–40 to +85°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
High-level Input Voltage	V_{IH}	—	V_{DD}×0.85	—	—	V
Low-level Input Voltage	V_{IL}	—	—	—	V_{DD}×0.2	V
High-level output Voltage	V_{OH}	I_{OH}=–40 µA	V_{DD}–0.3	—	—	V
Low-level output Voltage	V_{OL}	I_{OL}=2 mA	—	—	0.45	V
High-level Input Current (*1)	I_{IH1}	V_{IH}=V_{DD}	—	—	10	µA
High-level Input Current (*2)	I_{IH2}	V_{IH}=V_{DD}	—	—	20	µA
High-level Input Current (*3)	I_{IH3}	DV_{DD}=AV_{DD}=4.5 to 5.5 V, V_{IH}=V_{DD}	30	150	300	µA
		DV_{DD}=AV_{DD}=2.7 to 3.6 V, V_{IH}=V_{DD}	10	50	100	µA
Low-level Input Current (*1)	I_{IL1}	V_{IL}=DGND	–10	—	—	µA
Low-level Input Current (*2)	I_{IL2}	V_{IL}=DGND	–20	—	—	µA
Operating Current consumption	I_{DD}	DV_{DD}=AV_{DD}=4.5 to 5.5 V, fosc=4.096 MHz, whithout load	—	15	30	mA
		DV_{DD}=AV_{DD}=2.7 to 3.6 V, fosc=4.096 MHz, whithout load	—	10	20	mA
Stanby Current consumption	I_{DDS}	At power down, without load Ta=–40 to +70°C	—	—	10	mA
		At power down, without load Ta=–40 to +85°C	—	—	50	mA

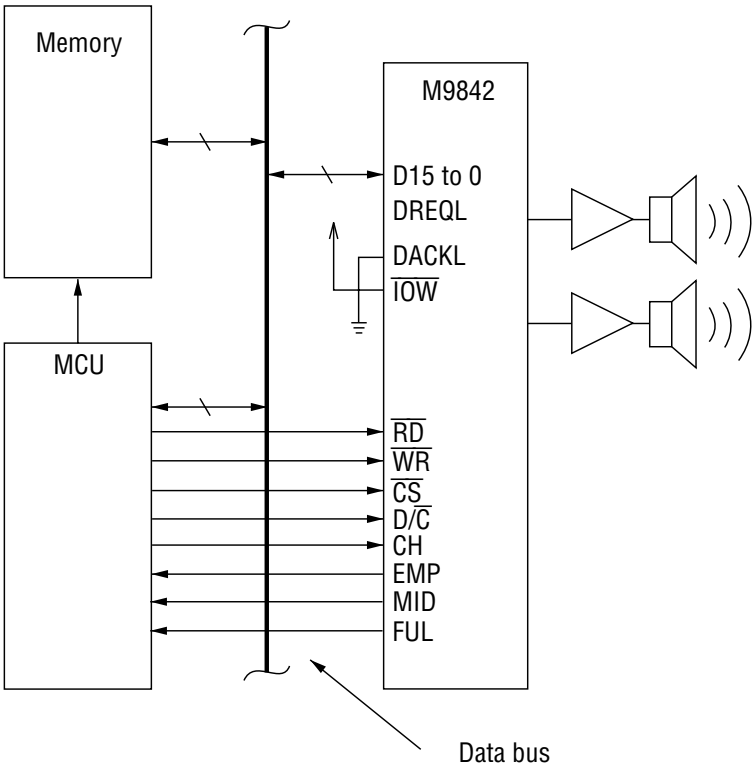
*1 Applicable to input excluding XT pin.
*2 Applicable to XT pin.
*3 Applicable to TEST0, TEST1.

CPU INTERFACE EXAMPLES

1) Interface when DMA controler is used (16-bit bus)



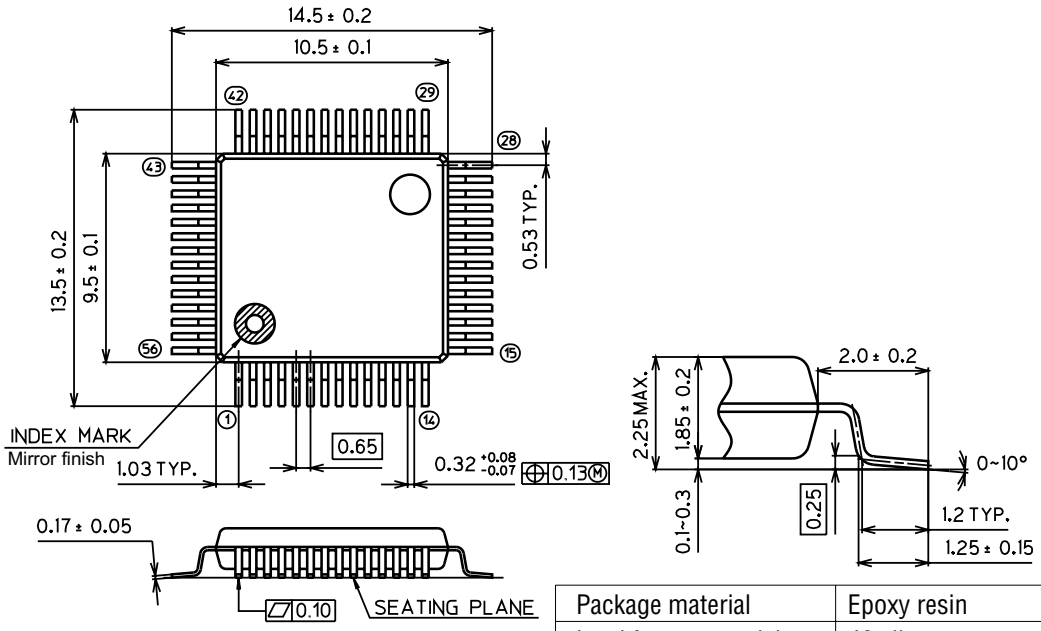
2) MCU & external memory interface (16-bit bus)



PACKAGE DIMENSIONS

(Unit : mm)

QFP56-P-910-0.65-2K



Package material	Epoxy resin
Lead frame material	42 alloy
Pin treatment	Solder plating (≥5 µm)
Package weight (g)	0.43 TYP.
Rev. No./Last Revised	4/Nov. 28, 1996

Oki Electric Industry Co., Ltd.

Notes for Mounting the Surface Mount Type Package

The SOP, QFP, TSOP, SOJ, QFJ (PLCC), SHP and BGA are surface mount type packages, which are very susceptible to heat in reflow mounting and humidity absorbed in storage.
Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

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Printed in Japan